



Product Summary

| BV _{DSS} | RDS(ON) Max | I _D Ta = +25°C |
|-------------------|--------------------------------|------------------------------|
| -40V | $11m\Omega @ V_{GS} = -10V$ | -10.8A |
| | 15mΩ @ V _{GS} = -4.5V | -9.6A |

This MOSFET is designed to meet the stringent requirements of

automotive applications. It is qualified to AEC-Q101, supported by a

40V P-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production Low On-Resistance
- Low Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP4016SSSQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: SO-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Lead-Frame. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)



Description and Applications

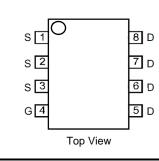
PPAP, and is ideal for use in:

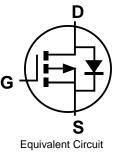
DC-DC converters

Analog switches

Power-management functions

Top View





Ordering Information (Note 4)

| Part Number | Backaga | Packing | | |
|----------------|---------|---------|-------------|--|
| Fart Number | Package | Qty. | Carrier | |
| DMP4016SSSQ-13 | SO-8 | 2,500 | Tape & Reel | |

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

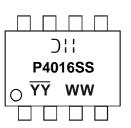
Lead-free.

Notes:

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

| Characteristic | | | Symbol | Value | Unit |
|--|-----------------|--|--------|---------------|------|
| Drain-Source Voltage | Vdss | -40 | V | | |
| Gate-Source Voltage | | V _{GSS} | ±20 | V | |
| Continuous Drain Current (Note 6) V _{GS} = -10V | Steady State | T _A = +25°C T _A = +70°C | ID | -10.8 -8.6 | А |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | | | Ідм | -112 | A |
| Maximum Body Diode Continuous Current (Note 6) | | | ls | -10.8 | A |
| Avalanche Current, L = 1mH | | | las | -26 | A |
| Avalanche Energy, L = 1mH | | | Eas | 338 | mJ |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|------------------|-------------|------|
| Total Power Dissipation (Note 5) | PD | 1.6 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | R _{0JA} | 80.2 | °C/W |
| Total Power Dissipation (Note 6) | PD | 2.1 | W |
| Thermal Resistance, Junction to Ambient (Note 6) | Reja | 60.4 | °C/W |
| Thermal Resistance, Junction to Case (Note 6) | Rejc | 7.8 | °C/W |
| Operating and Storage Temperature Range | TJ, TSTG | -55 to +150 | °C |

Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|---|--------------------|------|------|------|-------|---|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | -40 | | | V | $V_{GS} = 0V, I_D = -250 \mu A$ | |
| Zero Gate Voltage Drain Current | IDSS | _ | _ | -1 | μA | $V_{DS} = -40V, V_{GS} = 0V$ | |
| Gate-Source Leakage | IGSS | _ | _ | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 7) | | | | | | | |
| Gate Threshold Voltage | VGS(TH) | -1.5 | — | -2.5 | V | $V_{DS} = V_{GS}$, $I_D = -250 \mu A$ | |
| Static Drain-Source On-Resistance | Descent | | 6 | 11 | mΩ | $V_{GS} = -10V, I_D = -9.8A$ | |
| | RDS(ON) | _ | 8.5 | 15 | 11152 | V _{GS} = -4.5V, I _D = -9.8A | |
| Diode Forward Voltage | Vsd | _ | -0.7 | -1 | V | $V_{GS} = 0V, I_{S} = -1A$ | |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | | |
| Input Capacitance | Ciss | _ | 5697 | | | $V_{DS} = -20V, V_{GS} = 0V$ f = 1MHz | |
| Output Capacitance | Coss | | 534 | | pF | | |
| Reverse Transfer Capacitance | Crss | _ | 408 | | | | |
| Gate Resistance | Rg | _ | 7 | | Ω | $V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$ | |
| Total Gate Charge (V _{GS} = -4.5V) | Qg | _ | 53 | _ | | | |
| Total Gate Charge (V _{GS} = -10V) | Qg | _ | 112 | _ | nC | V _{DS} = -20V, I _D = -9.8A | |
| Gate-Source Charge | Qgs | | 20 | | nc | | |
| Gate-Drain Charge | Qgd | _ | 18 | _ | | | |
| Turn-On Delay Time | t _{D(ON)} | | 11.5 | | | $V_{GS} = -10V, V_{DD} = -20V,$ $R_G = 2\Omega, I_D = -9.8A$ | |
| Turn-On Rise Time | tR | | 41 | | | | |
| Turn-Off Delay Time | tD(OFF) | _ | 146 | _ | ns | | |
| Turn-Off Fall Time | tF | _ | 165 | _ | | | |
| Reverse Recovery Time | t _{RR} | _ | 27 | _ | ns | IF = -9.8A, di/dt = -100A/µs | |
| Reverse Recovery Charge | Q _{RR} | _ | 22 | _ | nC | I _F = -9.8A, di/dt = -100A/µs | |

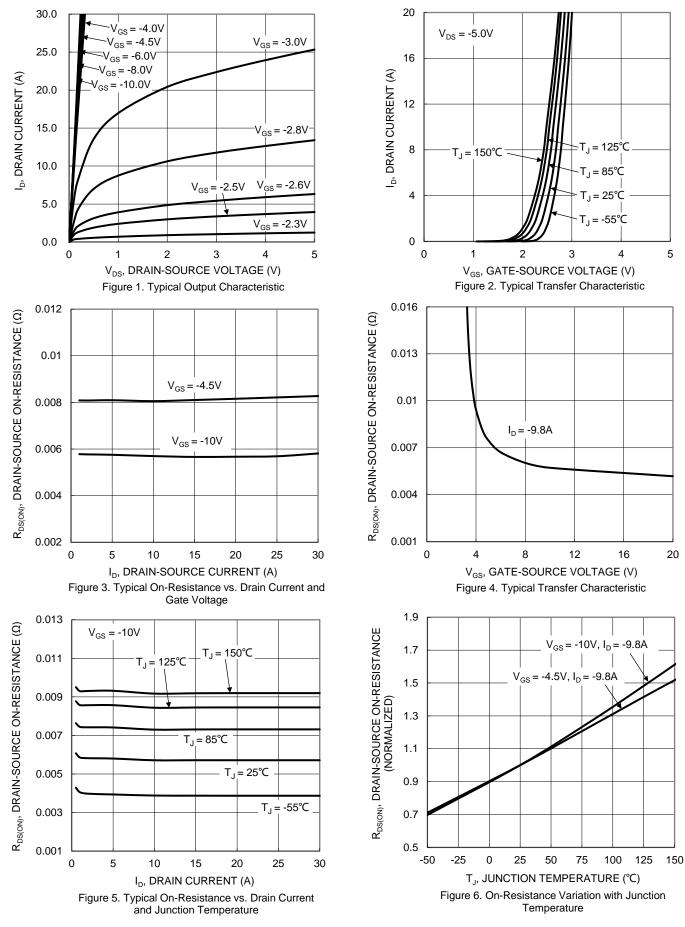
Notes: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

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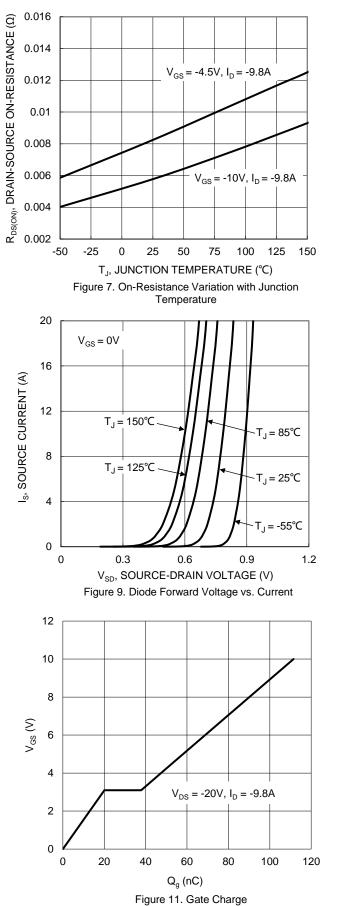
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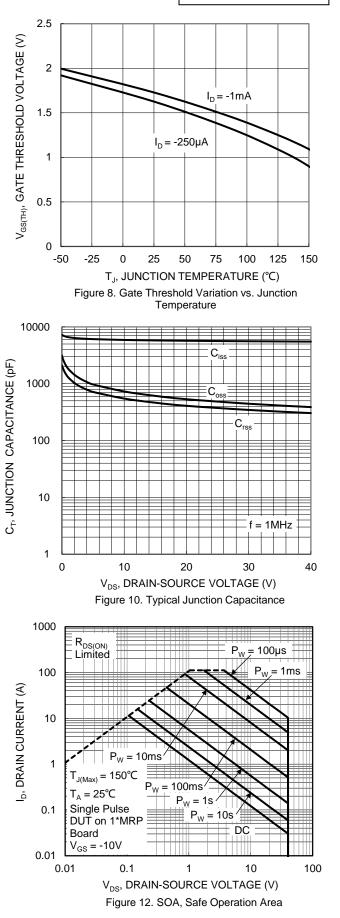


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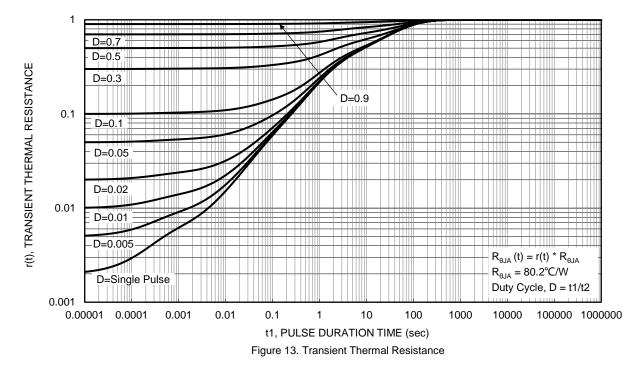
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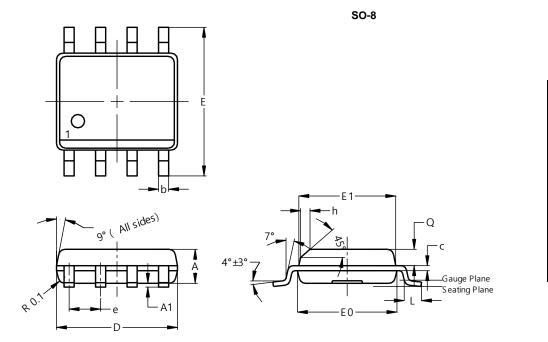






Package Outline Dimensions

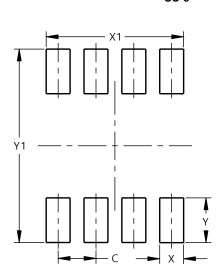
Please see http://www.diodes.com/package-outlines.html for the latest version.



| SO-8 | | | | | | |
|----------------------|------|------|------|--|--|--|
| Dim | Min | Max | Тур | | | |
| Α | 1.40 | 1.50 | 1.45 | | | |
| A1 | 0.10 | 0.20 | 0.15 | | | |
| b | 0.30 | 0.50 | 0.40 | | | |
| С | 0.15 | 0.25 | 0.20 | | | |
| D | 4.85 | 4.95 | 4.90 | | | |
| ш | 5.90 | 6.10 | 6.00 | | | |
| E1 | 3.80 | 3.90 | 3.85 | | | |
| E0 | 3.85 | 3.95 | 3.90 | | | |
| е | - | | 1.27 | | | |
| h | | | 0.35 | | | |
| L | 0.62 | 0.82 | 0.72 | | | |
| Q | 0.60 | 0.70 | 0.65 | | | |
| All Dimensions in mm | | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 1.27 |
| Х | 0.802 |
| X1 | 4.612 |
| Y | 1.505 |
| Y1 | 6.50 |

SO-8



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